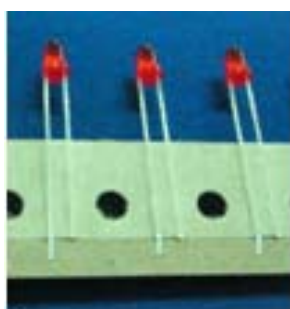


LAMP

204-10SDRD/S530-A3/TR1-1(R)



Features

- Long life feature.
- Low power consumption.
- High emitting efficiency.
- Most radial lead plastic LED lamp a coil able packed in tape and reel.
- Reel package simplifies handling and test.
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)

Description

- The 204-10 lamps are made with AlGaInP diodes which emit Deep Red
- Automatically insertable with radial lead insertion equipment.

Applications

- | | |
|----------------------|---------------------|
| •Audio equipment | •Satellite receiver |
| •Monitor | •Burglar alarm |
| •Sign board | •Stop light |
| •Computer peripheral | |
| •Air conditioner | |
| •Home appliance | |

Device Selection Guide

PART NO.	Chip Materials	Emitted Color	Resin Color
204-10SDRD/S530-A3-L	AlGaInP	Deep Red	Red Diffused

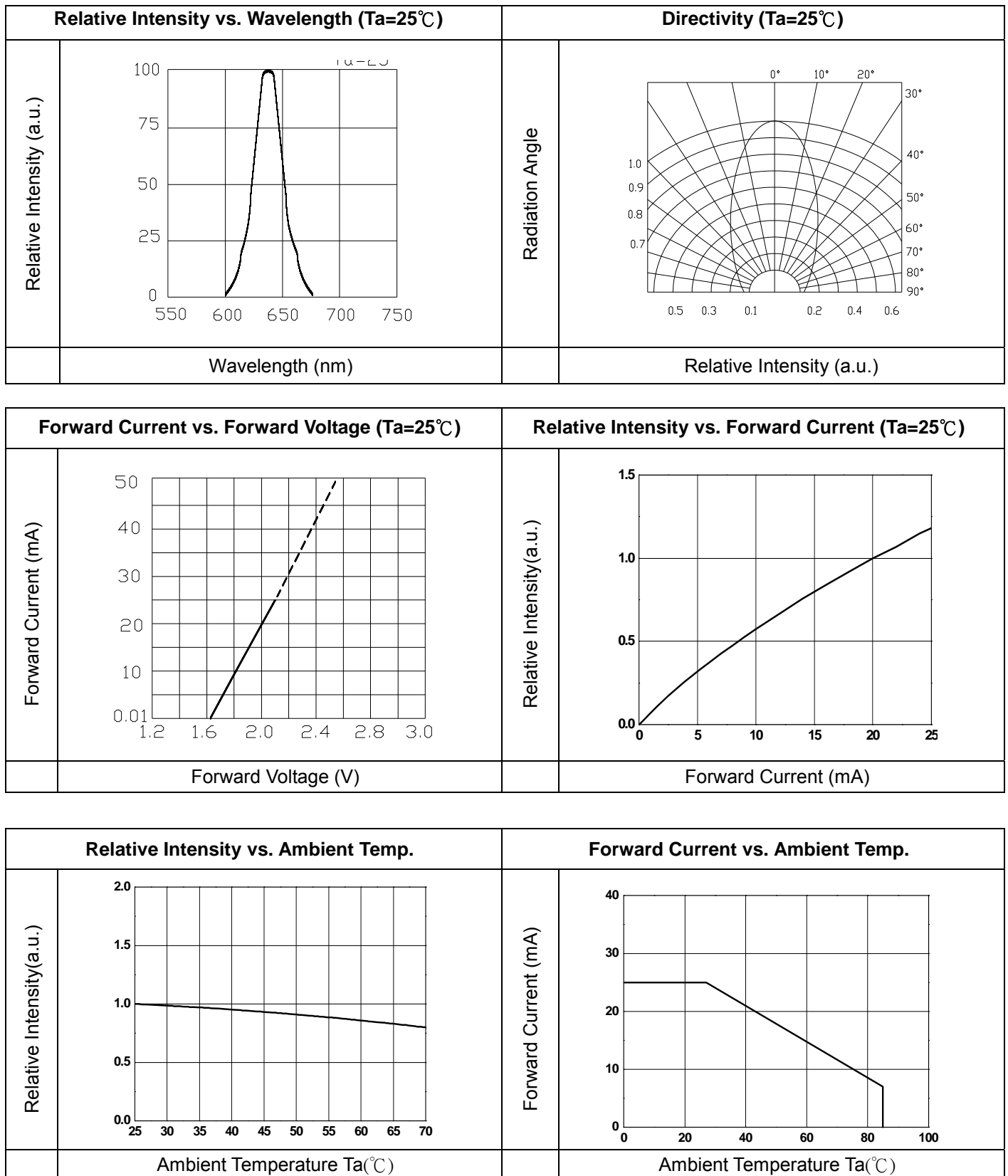
Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Continuous Forward Current	I _F	25	mA
Peak Forward Current (Duty 1/10 @ 1KHZ)	I _{FP}	60	mA
Reverse Voltage	V _R	5	V
Power Dissipation	P _d	60	mW
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +100	°C
Soldering Temperature	T _{sol}	260 °C for 5 sec.	

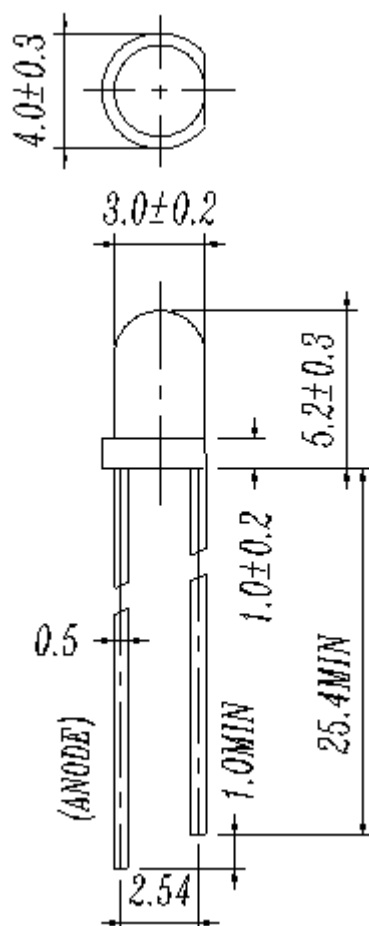
Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I _v	40	80	-----	mcd	I _F =20mA
Viewing Angle	2θ _{1/2}	-----	50	-----	deg	I _F =20mA
Peak Wavelength	λ _p	-----	650	-----	nm	I _F =20mA
Dominant Wavelength	λ _d	-----	639	-----	nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ	-----	20	-----	nm	I _F =20mA
Forward Voltage	V _F	1.7	2.0	2.4	V	I _F =20mA
Reverse Current	I _R	-----	-----	10	μA	V _R =5V

Typical Electro-Optical Characteristics Curves



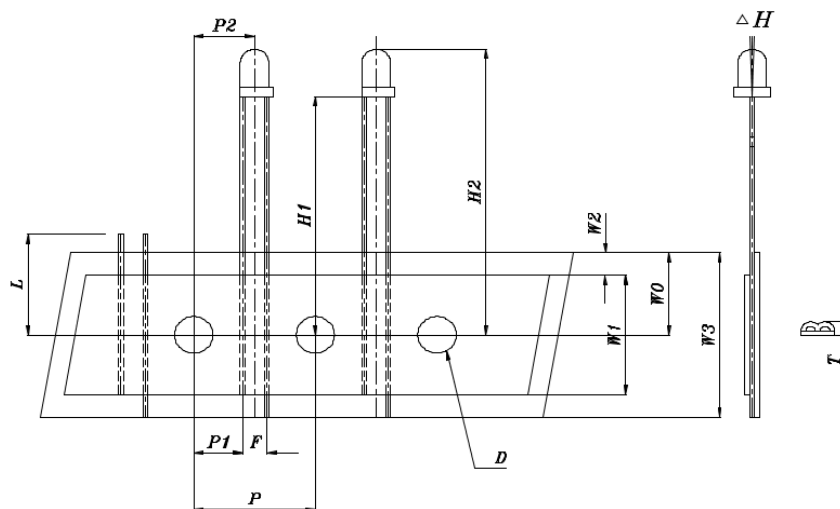
Package Dimension



Notes:

1. All dimensions are in millimeters, tolerance is $\pm 0.25 \text{ mm}$ except being specified
2. Lead spacing is measured where the lead emerge from the package
3. Protruded resin under flange is 1.5 mm ($0.059''$) Max LED.
4. The single LED picture which is after taping.

Carrier Tape Dimensions:



Notes:

- 1.All dimensions are in millimeters, tolerance is $\pm 0.25\text{mm}$ except being specified
- 2.Lead spacing is measured where the lead emerge from the package

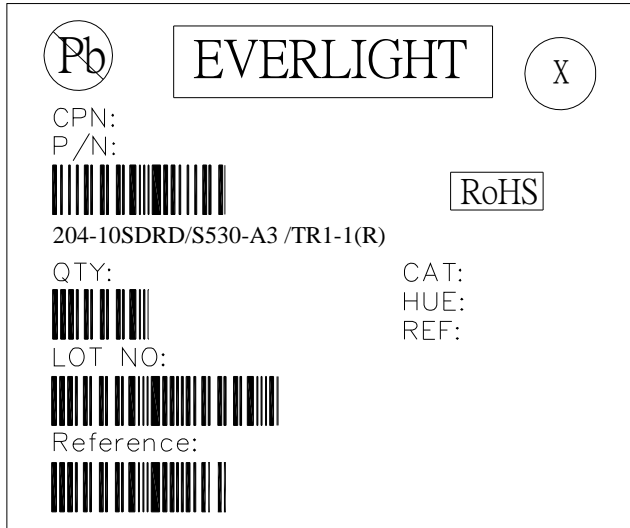
Taping Sizes

Symbol Items	Symbol	Specifications		
		Avg.		Tolerance
		mm	Inch	(mm)
Tape Feed Hole Diameter	D	4.0	0.157	± 0.2
Component Lead Pitch	F	2.54	0.100	$+0.8/-0.2$
Front-to-Read Deflection	ΔH	0°	0	$\pm 5^\circ$
Height of Seating Plane	H1	21.50	0.846	± 0.5
Feed Hole to Button of Component	H2	26.70	1.051	± 1.0
Feed Hole to Overall Component Height	L	11.00	0.433	± 1.0
Lead Length after Component Removal	P	12.70	0.500	MAX
Feed Hole Pitch	P1	5.08	0.200	± 0.3
Lead Location	P2	6.35	0.250	± 0.7
Center of Component Location	T	1.42	0.056	± 1.2
Overall Taped Package Thickness	W0	9.00	0.354	MAX
Feed Hole Location	W1	13.00	0.512	± 0.5
Adhesive Tape Width	W2	2.00	0.079	± 0.5
Adhesive Tape Position	W3	18.00	0.709	MAX

Note: Tolerances unless mentioned $\pm 0.1\text{mm}$. Unit = mm

Moisture Resistant Packing Materials

Label Explanation



CPN: Customer's Production Number

P/N : Production Number

QTY: Packing Quantity

CAT: Ranks of Luminous Intensity

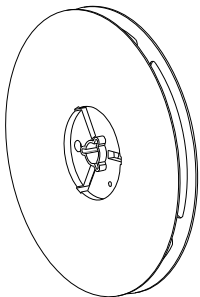
HUE: Ranks of Dominant Wavelength

REF: Ranks of Forward Voltage

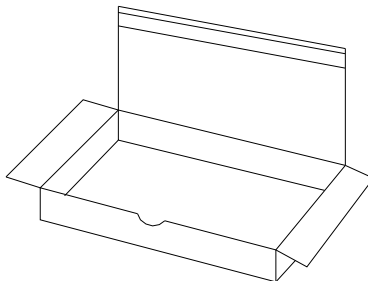
LOT No: Lot Number

Packing Specification

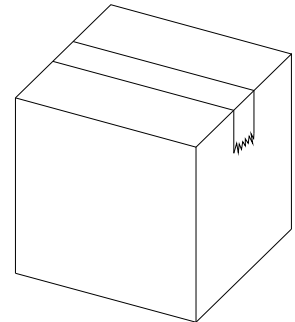
■ Tape



■ Inner Carton



■ Outside Carton



■ Packing Quantity

1. 2000 PCS/Tape, 2 Tapes/Inner Carton
2. 5 Inner Cartons/Outer box

Notes

1. Lead Forming

- During lead formation, the leads should be bent at a point at least 3mm from the base of the epoxy bulb.
- Lead forming should be done before soldering.
- Avoid stressing the LED package during leads forming. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- Cut the LED lead frames at room temperature. Cutting the lead frames at high temperatures may cause failure of the LEDs.
- When mounting the LEDs onto a PCB, the PCB holes must be aligned exactly with the lead position of the LED. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.

2. Storage

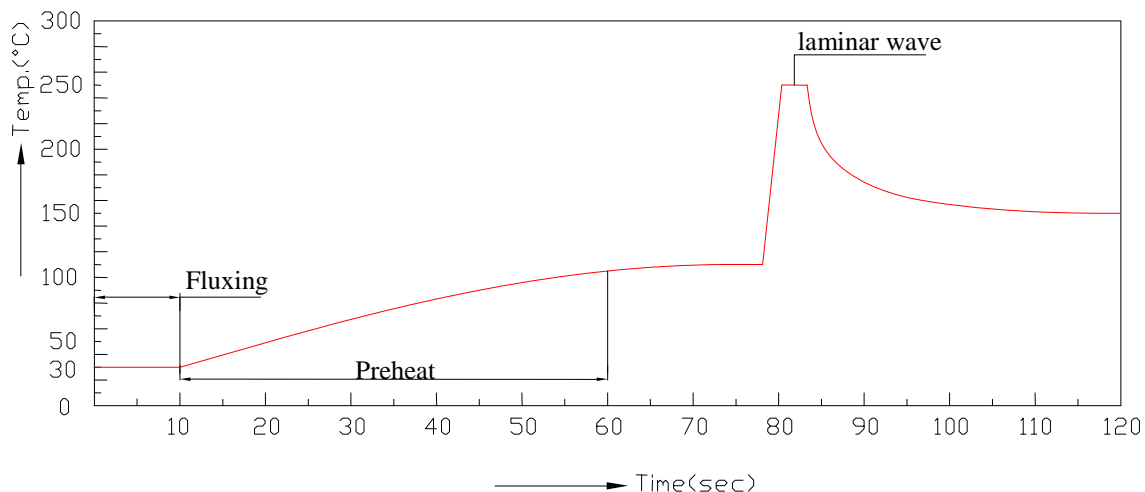
- The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Everlight and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

3. Soldering

- Careful attention should be paid during soldering. When soldering, leave more than 3mm from solder joint to epoxy bulb, and soldering beyond the base of the tie bar is recommended.
- Recommended soldering conditions:

Hand Soldering		DIP Soldering	
Temp. at tip of iron	300°C Max. (30W Max.)	Preheat temp.	100°C Max. (60 sec Max.)
Soldering time	3 sec Max.	Bath temp. & time	260 Max., 5 sec Max
Distance	3mm Min. (From solder joint to epoxy bulb)	Distance	3mm Min. (From solder joint to epoxy bulb)

- Recommended soldering profile



- Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.
- Dip and hand soldering should not be done more than one time
- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

- Although the recommended soldering conditions are specified in the above table, dip or hand soldering at the lowest possible temperature is desirable for the LEDs.
 - Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.
4. Cleaning
- When necessary, cleaning should occur only with isopropyl alcohol at room temperature for a duration of no more than one minute. Dry at room temperature before use.
 - Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Ultrasonic cleaning shall be pre-qualified to ensure this will not cause damage to the LED
5. Heat Management
- Heat management of LEDs must be taken into consideration during the design stage of LED application. The current should be de-rated appropriately by referring to the de-rating curve found in each product specification.
 - The temperature surrounding the LED in the application should be controlled. Please refer to the data sheet de-rating curve.
6. ESD (Electrostatic Discharge)
- The products are sensitive to static electricity or surge voltage. ESD can damage a die and its reliability.
When handling the products, the following measures against electrostatic discharge are strongly recommended:
 - Eliminating the charge
 - Grounded wrist strap, ESD footwear, clothes, and floors
 - Grounded workstation equipment and tools
 - ESD table/shelf mat made of conductive materials
 - Proper grounding is required for all devices, equipment, and machinery used in product assembly.
Surge protection should be considered when designing of commercial products.
 - If tools or equipment contain insulating materials such as glass or plastic,
the following measures against electrostatic discharge are strongly recommended:
 - Dissipating static charge with conductive materials
 - Preventing charge generation with moisture
 - Neutralizing the charge with ionizers
7. Directions for use
- The LEDs should be operated with forward bias. The driving circuit must be designed so that the LEDs are not subjected to forward or reverse voltage while it is off. If reverse voltage is continuously applied to the LEDs, it may cause migration resulting in LED damage.
8. Other
- Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
 - When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply
with the absolute maximum ratings and the instructions included in these specification sheets.

- These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.